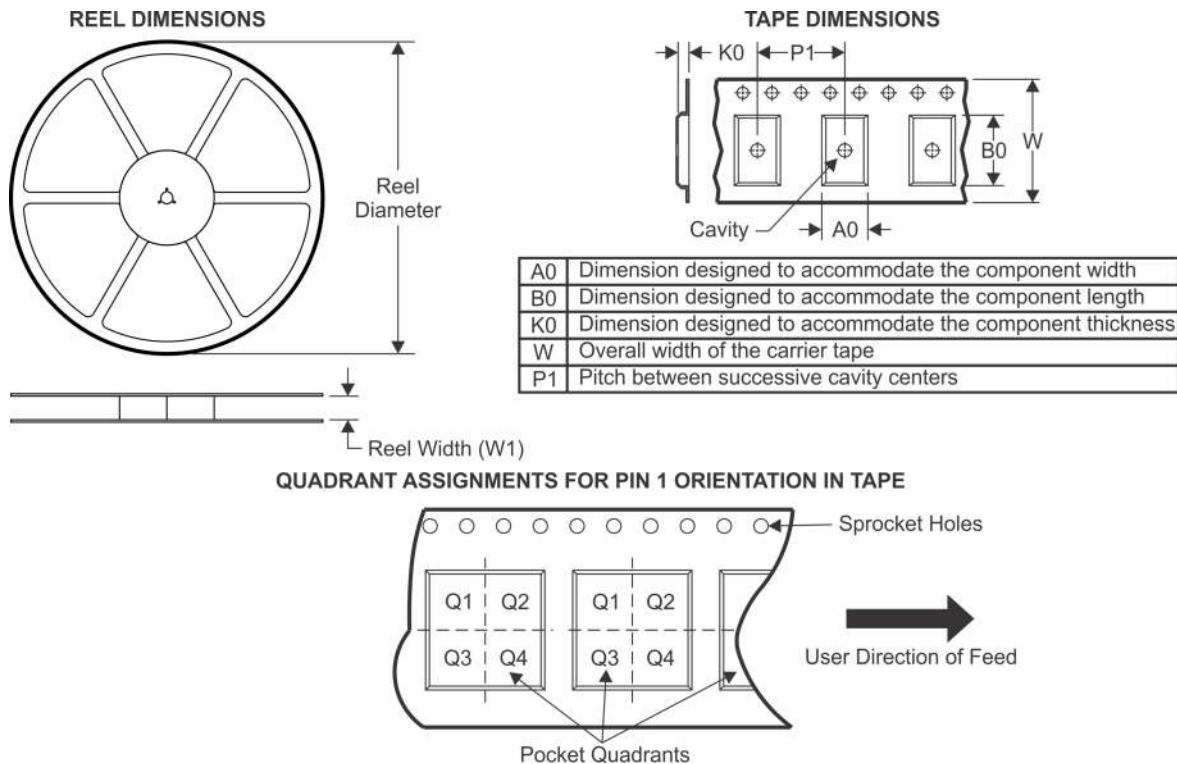


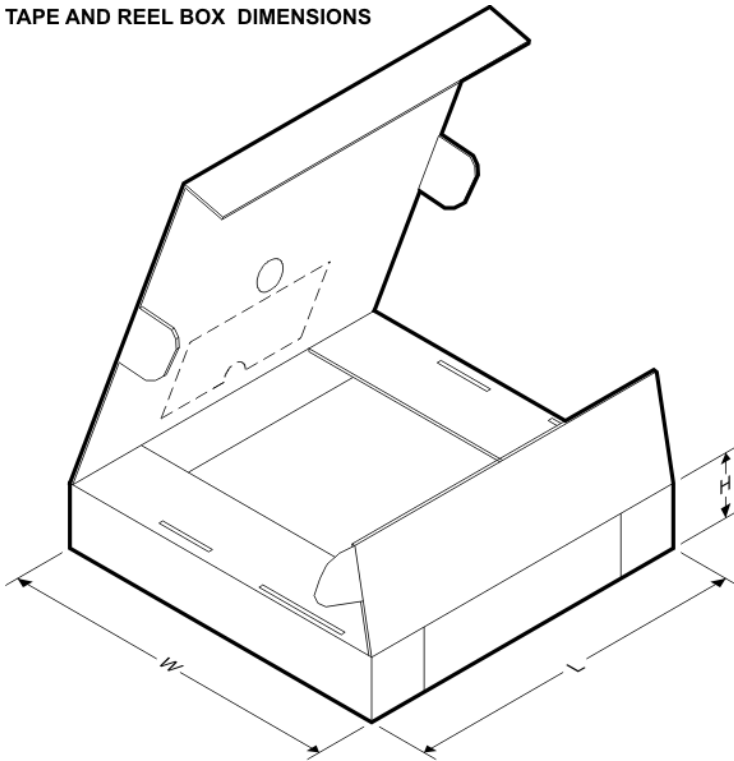
TAPE AND REEL INFORMATION



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LVC08ADR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
SN74LVC08ADR	SOIC	D	14	2500	330.0	16.8	6.5	9.5	2.1	8.0	16.0	Q1
SN74LVC08ADR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
SN74LVC08ADRG3	SOIC	D	14	2500	330.0	16.8	6.5	9.5	2.1	8.0	16.0	Q1
SN74LVC08ADRG4	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
SN74LVC08ADRG4	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
SN74LVC08ADT	SOIC	D	14	250	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
SN74LVC08ANSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
SN74LVC08APWR	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
SN74LVC08APWRG3	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
SN74LVC08APWRG4	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
SN74LVC08APWT	TSSOP	PW	14	250	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
SN74LVC08ARGYR	VQFN	RGY	14	3000	330.0	12.4	3.75	3.75	1.15	8.0	12.0	Q1

TAPE AND REEL BOX DIMENSIONS



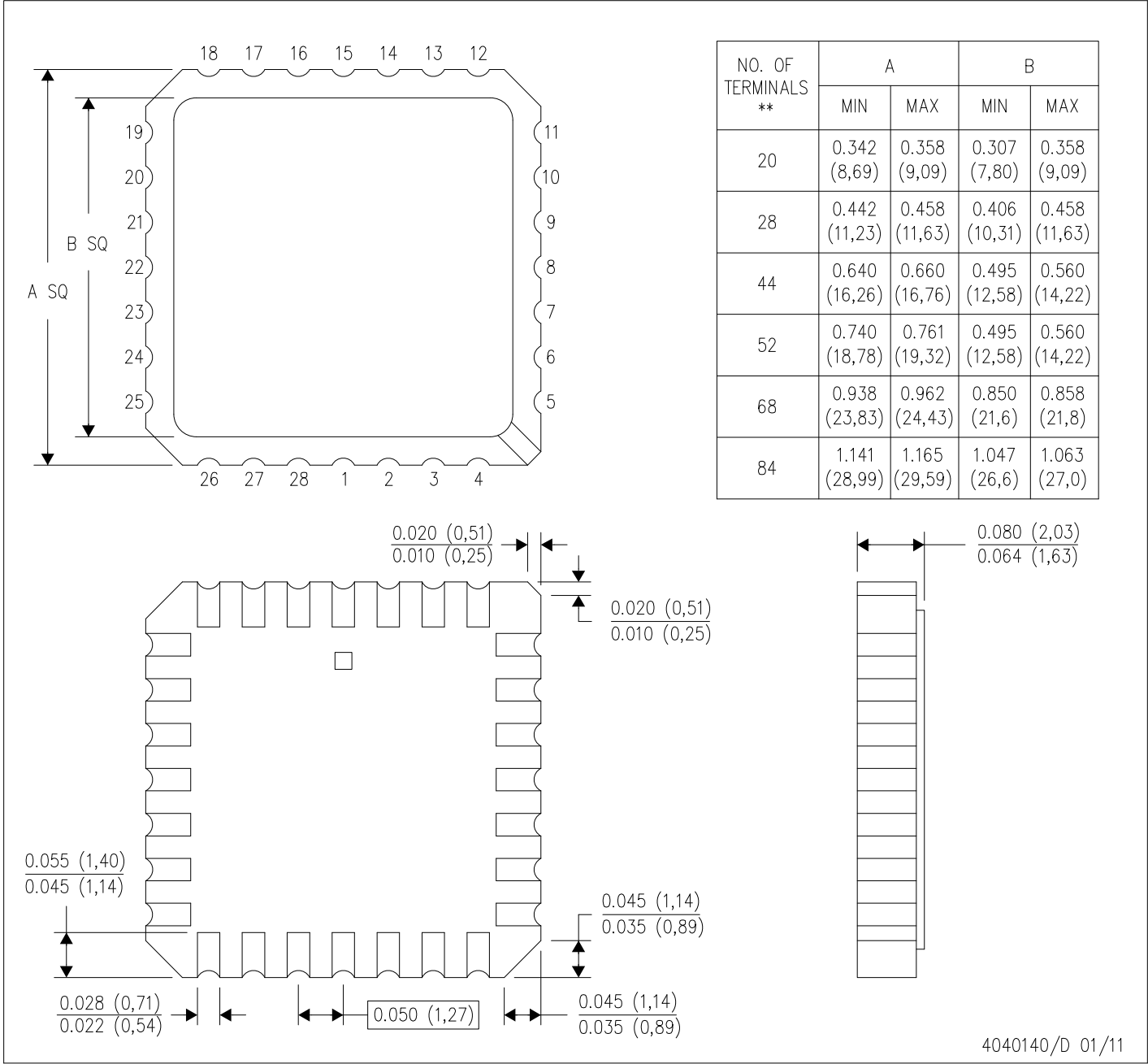
*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LVC08ADR	SOIC	D	14	2500	367.0	367.0	38.0
SN74LVC08ADR	SOIC	D	14	2500	364.0	364.0	27.0
SN74LVC08ADR	SOIC	D	14	2500	333.2	345.9	28.6
SN74LVC08ADRG3	SOIC	D	14	2500	364.0	364.0	27.0
SN74LVC08ADRG4	SOIC	D	14	2500	333.2	345.9	28.6
SN74LVC08ADRG4	SOIC	D	14	2500	367.0	367.0	38.0
SN74LVC08ADT	SOIC	D	14	250	210.0	185.0	35.0
SN74LVC08ANSR	SO	NS	14	2000	367.0	367.0	38.0
SN74LVC08APWR	TSSOP	PW	14	2000	367.0	367.0	35.0
SN74LVC08APWRG3	TSSOP	PW	14	2000	364.0	364.0	27.0
SN74LVC08APWRG4	TSSOP	PW	14	2000	367.0	367.0	35.0
SN74LVC08APWT	TSSOP	PW	14	250	367.0	367.0	35.0
SN74LVC08ARGYR	VQFN	RGY	14	3000	367.0	367.0	35.0

FK (S-CQCC-N**)

28 TERMINAL SHOWN

LEADLESS CERAMIC CHIP CARRIER



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package can be hermetically sealed with a metal lid.
 - D. Falls within JEDEC MS-004